

## TrenchP™ Power MOSFETs

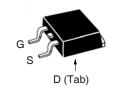
### IXTA28P065T IXTP28P065T

 $V_{DSS} = -65V$   $I_{D25} = -28A$   $R_{DS(2D)} \le 45m\Omega$ 

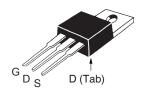
P-Channel Enhancement Mode Avalanche Rated



#### **TO-263 AA (IXTA)**



#### TO-220AB (IXTP)



G = Gate	D	= Drain
S = Source	Tab	= Drain

Symbol	Test Conditions	Maximum F	Ratings
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	- 65	V
$\mathbf{V}_{\mathtt{DGR}}$	$T_{_{ m J}}$ = 25°C to 150°C, $R_{_{ m GS}}$ = 1M $\Omega$	- 65	V
V <sub>GSS</sub>	Continuous	±15	V
V <sub>GSM</sub>	Transient	±25	V
I <sub>D25</sub>	T <sub>c</sub> = 25°C	- 28	Α
I <sub>DM</sub>	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	- 90	Α
I <sub>A</sub>	T <sub>c</sub> = 25°C	- 28	Α
E <sub>s</sub>	$T_{c} = 25^{\circ}C$	200	mJ
P <sub>D</sub>	$T_{c} = 25^{\circ}C$	83	W
T <sub>J</sub>		-55 +150	°C
T <sub>JM</sub>		150	°C
T <sub>stg</sub>		-55 +150	°C
$T_L$	1.6mm (0.062 in.) from Case for 10s	300	°C
T <sub>SOLD</sub>	Plastic Body for 10s	260	°C
M <sub>d</sub>	Mounting Torque (TO-220)	1.13 / 10	Nm/lb.in.
Weight	TO-220 TO-263	3.0 2.5	g g

#### **Features**

- International Standard Packages
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Diode
- $^{\bullet}$  Low  $\rm R_{\rm \tiny DS(ON)}$  and  $\rm Q_{\rm \tiny G}$

#### **Advantages**

- Easy to Mount
- Space Savings
- High Power Density

### **Applications**

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

#### **Characteristic Values** Symbol **Test Conditions** (T<sub>J</sub> = 25°C, Unless Otherwise Specified) Max. Min. Тур. $V_{GS} = 0V, I_{D} = -250\mu A$ $\mathbf{BV}_{\mathrm{DSS}}$ - 65 $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ - 2.5 - 4.5 V V<sub>GS(th)</sub> $V_{GS} = \pm 15V, V_{DS} = 0V$ ±50 nA l<sub>GSS</sub> $V_{DS} = V_{DSS}, V_{GS} = 0V$ -3 μA I<sub>DSS</sub> T<sub>.</sub> = 125°C -100 μA $\boldsymbol{R}_{\text{DS}(\underline{on})}$ $V_{GS} = -10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$ 45 $m\Omega$



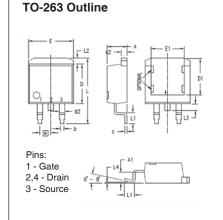
<b>Symbo</b> (T <sub>J</sub> = 25		Test Conditions Unless Otherwise Specified)	Charae Min.	cteristic ' Typ.	Values Max.
g <sub>fs</sub>		$V_{DS} = -10V, I_{D} = 0.5 \cdot I_{D25}, \text{ Note 1}$	10	16	S
C <sub>iss</sub>	)			2030	pF
C <sub>oss</sub>	}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		270	pF
$\mathbf{C}_{rss}$	J			127	pF
t <sub>d(on)</sub>	)	Resistive Switching Times		21	ns
t,		_		29	ns
$\mathbf{t}_{d(off)}$	1	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		36	ns
t <sub>f</sub>	J	$R_{g} = 10\Omega$ (External)		23	ns
Q <sub>g(on)</sub>	)			46	nC
$Q_{gs}$	}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		20	nC
$\mathbf{Q}_{gd}$	J			10	nC
R <sub>thJC</sub>					1.5 °C/W
$\mathbf{R}_{\mathrm{thCS}}$		TO-220		0.50	°C/W

#### Source-Drain Diode

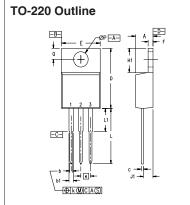
Symbol $(T_J = 25^{\circ}C, U)$		hara ⁄lin.	cteristic Typ.	Values Max.	
I <sub>s</sub>	$V_{GS} = 0V$			- 28	Α
I <sub>sm</sub>	Repetitive, Pulse Width Limited by $T_{JM}$			-112	Α
V <sub>SD</sub>	$I_{\rm F} = -28A, V_{\rm GS} = 0V, \text{ Note 1}$			-1.5	V
$\left\{egin{array}{c} \mathbf{t}_{rr} & \ \mathbf{Q}_{RM} \ \mathbf{I}_{RM} \end{array} \right\}$	$I_{_{\rm F}}$ = -14A, -di/dt = -100A/ $\mu$ s $V_{_{\rm R}}$ = - 33V, $V_{_{\rm GS}}$ = 0V		31 34 - 2.2		ns nC A

1. Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ . Note

# IXTP28P065T



MY2	INCHES		MILLIMETERS	
21M	MIN	MAX	MIN	MAX
Α	.160	.190	4.06	4.83
A1	.080.	.110	2.03	2.79
Ь	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
С	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
Ε	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
е	.100 BSC 2.54 BS		BSC	
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13



ns:	1 - Gate	2 - Drain
	3 - Source	

MYZ	INCHES		MILLIMETERS		
311	MIN	MAX	MIN	MAX	
Α	.170	.190	4.32	4.83	
b	.025	.040	0.64	1.02	
b1	.045	.065	1.15	1.65	
С	.014	.022	0.35	0.56	
D	.580	.630	14.73	16.00	
E	.390	.420	9.91	10.66	
е	.100 BSC		2.54 BSC		
F	.045	.055	1.14	1.40	
H1	.230	.270	5.85	6.85	
J1	.090	.110	2.29	2.79	
k	0	.015	0	0.38	
L	.500	.550	12.70	13.97	
L1	.110	.230	2.79	5.84	
ØΡ	.139	.161	3.53	4.08	
Q	.100	.125	2.54	3.18	



Fig. 1. Output Characteristics @ T<sub>J</sub> = 25°C

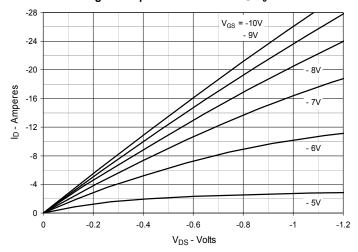


Fig. 2. Extended Output Characteristics @ T<sub>J</sub> = 25°C

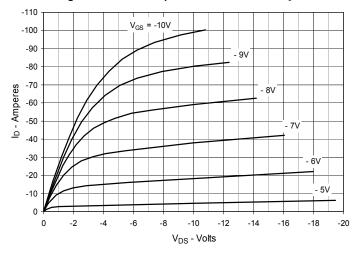


Fig. 3. Output Characteristics @  $T_J = 125^{\circ}C$ 

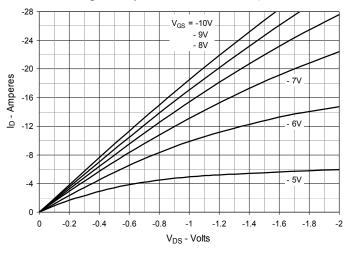


Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = -14A$  Value vs. Junction Temperature

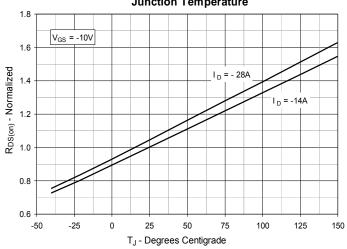


Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = -14A$  Value vs.

Drain Current

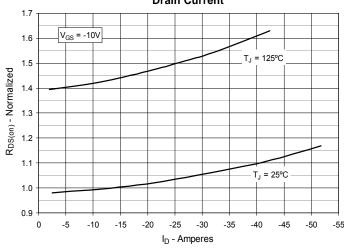
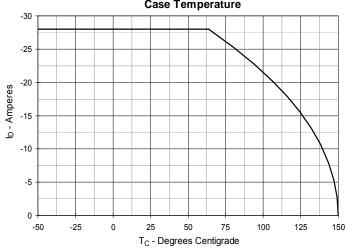
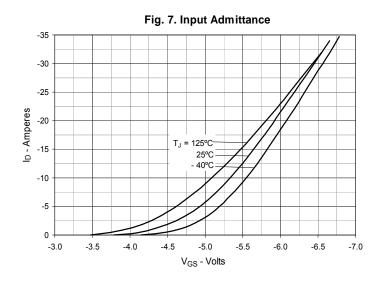


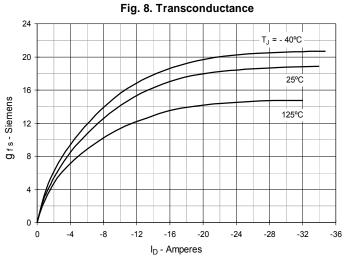
Fig. 6. Maximum Drain Current vs.

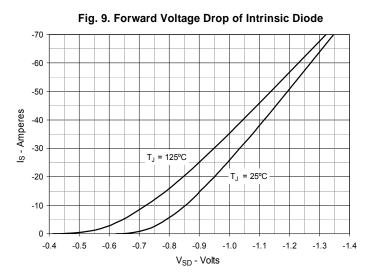
Case Temperature

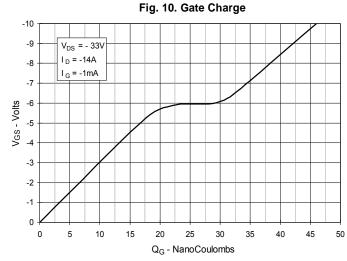


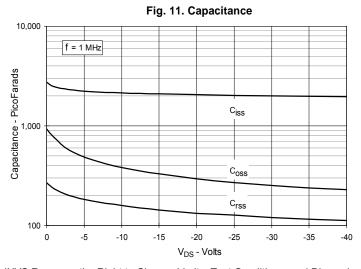


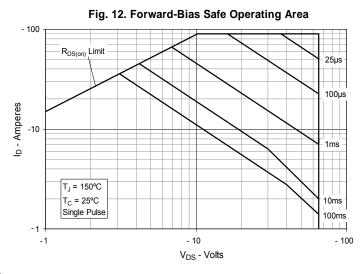












 $\ensuremath{\mathsf{IXYS}}$  Reserves the Right to Change Limits, Test Conditions, and Dimensions.



Fig. 13. Resistive Turn-on Rise Time vs.
Junction Temperature

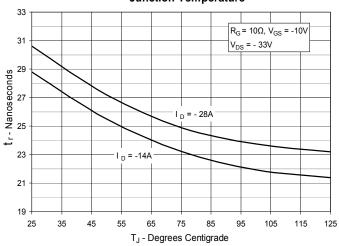


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

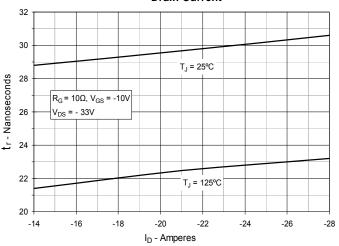


Fig. 15. Resistive Turn-on Switching Times vs.
Gate Resistance

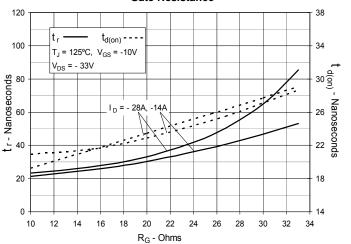


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature

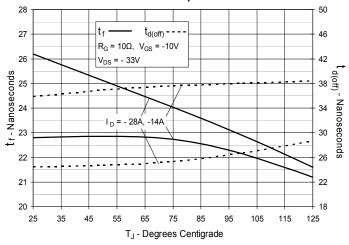


Fig. 17. Resistive Turn-off Switching Times vs.

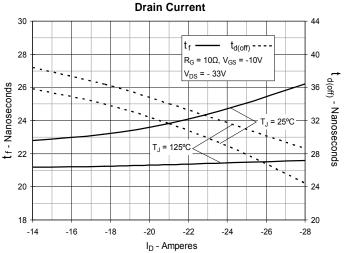
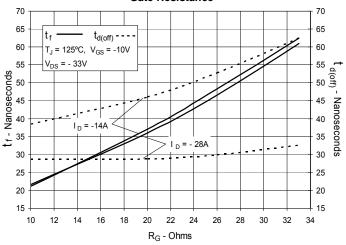


Fig. 18. Resistive Turn-off Switching Times vs.
Gate Resistance





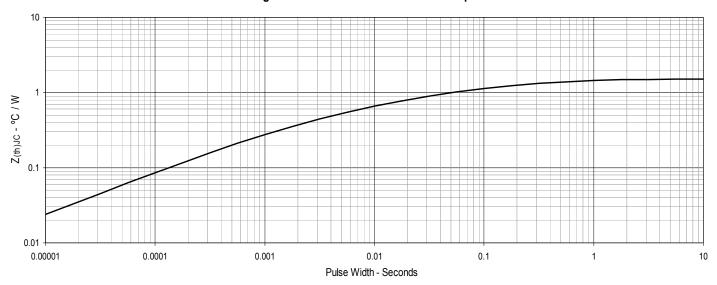


Fig. 19. Maximum Transient Thermal Impedance

